

DESCRIPTION

The HY5117100 is the new generation and fast dynamic RAM organized 16,777,216 x 1-bit. The HY5117100 utilizes Hyundai's CMOS silicon gate process technology as well as advanced circuit techniques to provide wide operating margins to the users. Multiplexed address inputs permit the HY5117100 to be packaged in standard 24/28 pin plastic SOJ, TSOP-II and Reverse TSOP-II.

The package size provides high system bit densities and is compatible with widely available automated testing and insertion equipments. System oriented feature includes single power supply of 5V± 10% tolerance and direct interfacing capability with high performance logic families such as Schottky TTL.

FEATURES

- Low power dissipation
Max. battery back-up 2.75mW (L-part)
Max. CMOS standby 2.2mW (L-part)
5.5mW

Max. TTL standby 11.0mW

Max. operating

Speed	Power
60	715mW
70	633mW
80	550mW

- Single power supply of 5V± 10%
- TTL compatible inputs and outputs
- Fast access time

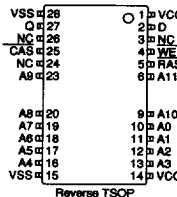
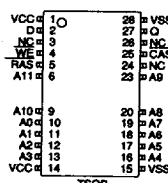
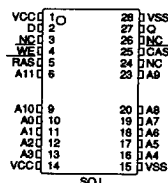
Speed	t _{RAC}	t _{CAC}	t _{PC}
60	60ns	15ns	40ns
70	70ns	18ns	45ns
80	80ns	20ns	50ns

- Fast page mode operation
- Multi-bit test capability
- Read-Modify-Write capability
- CAS-before-RAS, RAS-only, Hidden refresh
- 2048 refresh cycles / 256ms (L-part)
- 2048 refresh cycles / 32ms

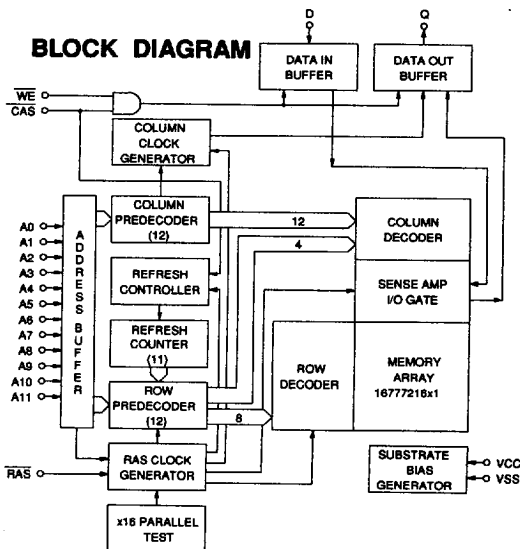
PIN DESCRIPTION

RAS	Row Address Strobe
CAS	Column Address Strobe
WE	Write Enable
A0-A11	Address Input
D	Data Input
Q	Data Output
VCC	Power (+ 5V)
VSS	Ground

PIN CONNECTION



BLOCK DIAGRAM



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ABSOLUTE MAXIMUM RATINGS

SYMBOL	PARAMETER	RATING	UNIT
TA	Ambient Temperature	0 to 70	°C
TSTG	Storage Temperature	-55 to 150	°C
VIN, VOUT	Voltage on Any Pin Relative to Vss	-1.0 to 7.0	V
VCC	Voltage on VCC Relative to Vss	-1.0 to 7.0	V
Ios	Short Circuit Output Current	50	mA
Pd	Power Dissipation	0.70	W
TSOLDER	Soldering Temperature• Time	260• 10	°C• sec

NOTE : Operation at or above Absolute Maximum Ratings can adversely affect device reliability.

RECOMMENDED DC OPERATING CONDITIONS

(TA= 0°C to 70°C)

SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNIT
VCC	Power Supply Voltage	4.5	5.0	5.5	V
Vih	Input High Voltage	2.4	-	VCC+ 1.0	V
Vil	Input Low Voltage	-1.0	-	0.8	V

NOTE : All voltages are referenced to Vss.

DC CHARACTERISTICS

(TA= 0°C to 70°C, VCC= 5V± 10%, VSS= 0V, unless otherwise noted.)

SYMBOL	PARAMETER	TEST CONDITIONS	SPEED/ POWER	MIN.	MAX.	UNIT	NOTE
ILI	Input Leakage Current (Any Input Pins)	VSS ≤ VIN ≤ VCC+ 1.0 All other pins not under test= VSS		-10	10	μA	
ILO	Output Leakage Current (High Impedance State)	VSS ≤ VOUT ≤ VCC, RAS & CAS at VIH		-10	10	μA	
ICC1	VCC Supply Current, Operating	trC= trC (min.)	60 70 80	- - -	130 115 100	mA	1,2,3
ICC2	VCC Supply Current, TTL Standby	RAS & CAS at VIH, other inputs ≥ VSS		-	2	mA	
ICC3	VCC Supply Current, RAS-only refresh	trC= trC (min.)	60 70 80	- - -	130 115 100	mA	1,3
ICC4	VCC Supply Current, Fast Page mode	trC= trC (min.)	60 70 80	- - -	70 65 60	mA	1,2,3
ICC5	VCC Supply Current, CMOS Standby	RAS & CAS ≥ VCC- 0.2V	L-part	-	1 0.4	mA	5
ICC6	VCC Supply Current, CAS-before-RAS refresh	trC= trC (min.)	60 70 80	- - -	130 115 100	mA	1,3
ICC7	VCC Supply Current, Battery Back Up (L-Part only)	trC= 125μs, CAS= CBR cycling or 0.2V, WE= VCC - 0.2V, A0-A11= VCC - 0.2V or 0.2V, D= VCC - 0.2V, 0.2V or open, Q= open	trAS ≤ 300ns	-	300	μA	1,4,5
			trAS ≤ 1μs	-	500		
VOL	Output Low Voltage	IOL= 4.2mA		-	0.4	V	
VOH	Output High Voltage	IOH= -5mA		2.4	-	V	

NOTE :

1. ICC1, ICC3, ICC4, ICC6 and ICC7 depend on cycle rate.
2. ICC1 and ICC4 depend on output loading. Specified values are obtained with the output open.
3. It depends on user whether column address is changed or not at least once while RAS= VIL and CAS= VIH.
4. trAS(max.)= 1μs is only applied to refresh of battery backup but trAS(max.)= 10μs is applied to normal functional operating.
5. ICC5(max.)= 0.4mA and ICC7 are applied to L-part only (HY5117100LJC, HY5117100LTC and HY5117100LRC).

AC CHARACTERISTICS

(TA= 0°C to 70°C, VCC= 5V± 10%, VSS= 0V, unless otherwise noted.) NOTE : 1, 2, 3

TA= 0°C to 70°C, VCC= 5V± 10%, VSS= 0V, unless otherwise noted. NOTE: 1, 2, 3										
#	SYMBOL	PARAMETER	HY5117100JC/TC/HC/LJC/LTC/LRC						UNIT	NOTE
			-60		-70		-80			
			MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
1	trc	Random Read or Write Cycle Time	110	-	130	-	150	-	ns	
2	trwc	Read-Modify-Write Cycle Time	130	-	155	-	175	-	ns	
3	tpc	Fast Page Mode Cycle Time	40	-	45	-	50	-	ns	
4	tprwc	Fast Page Mode Read-Modify-Write Cycle Time	60	-	70	-	75	-	ns	
5	trac	Access Time from RAS	-	60	-	70	-	80	ns	4,9,10
6	tcac	Access Time from CAS	-	15	-	18	-	20	ns	4,9
7	tAA	Access Time from Column Address	-	30	-	35	-	40	ns	4,10
8	tCPA	Access Time from CAS Precharge	-	35	-	40	-	45	ns	4
9	tCLZ	CAS to Output Low Impedance	0	-	0	-	0	-	ns	4
10	tOFF	Output Buffer Turn-off Delay	0	15	0	18	0	20	ns	5
11	tT	Transition Time (Rise and Fall)	3	50	3	50	3	50	ns	3
12	trp	RAS Precharge Time	40	-	50	-	60	-	ns	
13	trAS	RAS Pulse Width	60	10K	70	10K	80	10K	ns	
14	trASP	RAS Pulse Width (Fast Page Mode)	60	400K	70	400K	80	400K	ns	
15	trSH	RAS Hold Time	15	-	18	-	20	-	ns	
16	tCSH	CAS Hold Time	60	-	70	-	80	-	ns	
17	tCAS	CAS Pulse Width	15	10K	18	10K	20	10K	ns	
18	trCD	RAS to CAS Delay	20	45	20	52	20	60	ns	9
19	trAD	RAS to Column Address Delay Time	15	30	15	35	15	40	ns	10
20	tCRP	CAS to RAS Precharge Time	5	-	5	-	5	-	ns	
21	tCP	CAS Precharge Time	10	-	10	-	10	-	ns	
22	tASR	Row Address Set-up Time	0	-	0	-	0	-	ns	
23	trAH	Row Address Hold Time	10	-	10	-	10	-	ns	
24	tASC	Column Address Set-up Time	0	-	0	-	0	-	ns	
25	tCAH	Column Address Hold Time	10	-	15	-	15	-	ns	
26	tAR	Column Address Hold Time from RAS	50	-	55	-	60	-	ns	
27	trAL	Column Address to RAS Lead Time	30	-	35	-	40	-	ns	
28	trCS	Read Command Set-up Time	0	-	0	-	0	-	ns	
29	trCH	Read Command Hold Time Referenced to CAS	0	-	0	-	0	-	ns	6
30	trRH	Read Command Hold Time Referenced to RAS	0	-	0	-	0	-	ns	6
31	twCH	Write Command Hold Time	10	-	15	-	15	-	ns	
32	twCR	Write Command Hold Time from RAS	50	-	55	-	60	-	ns	
33	tWP	Write Command Pulse Width	10	-	15	-	15	-	ns	
34	trWL	Write Command to RAS Lead Time	15	-	18	-	20	-	ns	
35	tcWL	Write Command to CAS Lead Time	15	-	18	-	20	-	ns	
36	tDS	Data-In Set-up Time	0	-	0	-	0	-	ns	7
37	tDH	Data-In Hold Time	10	-	15	-	15	-	ns	7
38	tDHR	Data-In Hold Time Referenced to RAS	50	-	55	-	60	-	ns	
39	tREF	Refresh Period (2048 cycles)	-	32	-	32	-	32	ms	11
		L-part	-	256	-	256	-	256		
40	twCS	Write Command Set-up Time	0	-	0	-	0	-	ns	8

AC CHARACTERISTICS

(continued)

#	SYMBOL	PARAMETER	HY5117100JC/TC/RC/LJC/LTC/LRC						UNIT	NOTE
			-60		-70		-80			
			MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
41	tCWD	CAS to WE Delay Time	15	-	18	-	20	-	ns	8
42	tRWD	RAS to WE Delay Time	60	-	70	-	80	-	ns	8
43	tAWD	Column Address to WE Delay Time	30	-	35	-	40	-	ns	8
44	tCSR	CAS Set-up Time (CBR Cycle)	10	-	10	-	10	-	ns	
45	tCHR	CAS Hold Time (CBR Cycle)	10	-	15	-	15	-	ns	
46	tRPC	RAS to CAS Precharge Time	0	-	0	-	0	-	ns	
47	tCPT	CAS Precharge Time (CBR Counter Test)	20	-	25	-	25	-	ns	
48	tCPWD	WE Delay Time from CAS Precharge	35	-	40	-	45	-	ns	8
49	tRHCP	RAS Hold Time from CAS Precharge	35	-	40	-	45	-	ns	
50	tWRP	WE to RAS Precharge Time (CBR Cycle)	10	-	10	-	10	-	ns	
51	tWRH	WE to RAS Hold Time (CBR Cycle)	10	-	10	-	10	-	ns	
52	tWTS	Write Command Set-up Time (Test Mode In)	10	-	10	-	10	-	ns	
53	tWTH	Write Command Hold Time (Test Mode In)	10	-	10	-	10	-	ns	

NOTE :

1. An initial pause of 200 μ s is required after power-up followed by 8 **RAS** only refresh cycles before proper device operation is achieved. In case of using internal refresh counter, a minimum of 8 **CAS**-before-**RAS** initialization cycles instead of 8 **RAS**-only refresh cycles are required. The device should be carefully initialized to be prevented from being entered into multi bit test mode during initialization.
2. AC measurements assume $t_T = 5$ ns.
3. $V_{IH}(\text{min.})$ and $V_{IL}(\text{max.})$ are reference levels for measuring timing of input signals. Also, transition times are measured between V_{IH} and V_{IL} .
4. Measured with a load equivalent to 2 TTL loads and 100pF.
5. $t_{OFF}(\text{max.})$ defines the time at which the output achieves the open circuit condition and is not referenced to output voltage levels.
6. Either t_{RCH} or t_{RRH} must be satisfied for a read cycle.
7. These parameters are referenced to **CAS** leading edge in early write cycles and to **WE** leading edge in Read-Modify-Write cycles.
8. t_{WCS} , t_{RWD} , t_{CWD} , t_{AWD} and t_{CPWD} are not restrictive operating parameters. They are included in the data sheet as electrical characteristics only. If $t_{WCS} \geq t_{WCS}(\text{min.})$, the cycle is an early write cycle and data out pin will remain open circuit (high impedance) through the entire cycle. If $t_{RWD} \geq t_{RWD}(\text{min.})$, $t_{CWD} \geq t_{CWD}(\text{min.})$, $t_{AWD} \geq t_{AWD}(\text{min.})$, and $t_{CPWD} \geq t_{CPWD}(\text{min.})$, the cycle is a Read-Modify-Write cycle and data out will contain data read from the selected cell. If neither of the above sets of conditions is satisfied, the condition of the data out (at access time) is indeterminated.
9. Operation within the $t_{RCD}(\text{max.})$ limit insures that $t_{RAC}(\text{max.})$ can be met. $t_{RCD}(\text{max.})$ is specified as a reference point only. If t_{RCD} is greater than the specified $t_{RCD}(\text{max.})$ limit, then access time is controlled by t_{CAC} .
10. Operation within the $t_{RAD}(\text{max.})$ limit insures that $t_{RAC}(\text{max.})$ can be met. $t_{RAD}(\text{max.})$ is specified as a reference point only. If t_{RAD} is greater than the specified $t_{RAD}(\text{max.})$ limit, then access time is controlled by t_{AA} .
11. $t_{REF}(\text{max.}) = 256$ ms is applied to L-parts only (HY5117100LJC, HY5117100LTC and HY5117100LRC).

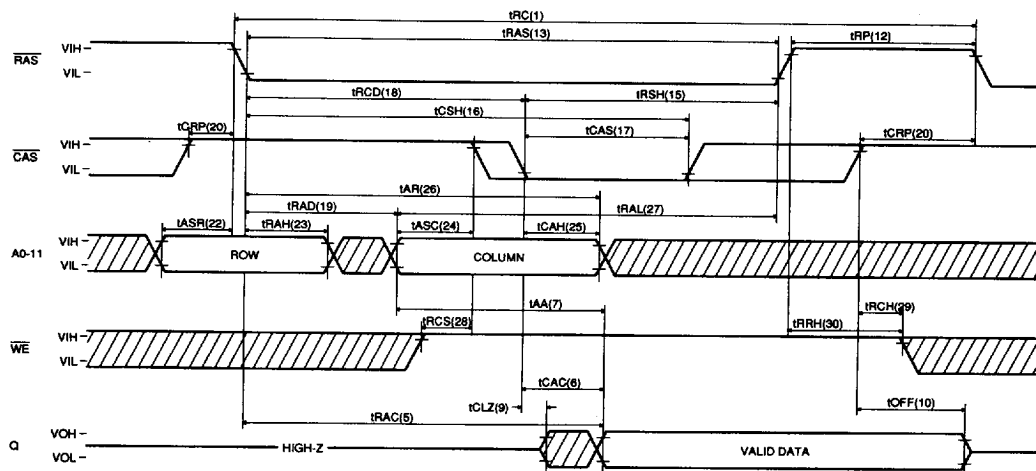
CAPACITANCE

($T_A = 25^\circ\text{C}$, $V_{CC} = 5\text{V} \pm 10\%$, $V_{SS} = 0\text{V}$, $f = 1\text{MHz}$, unless otherwise noted.)

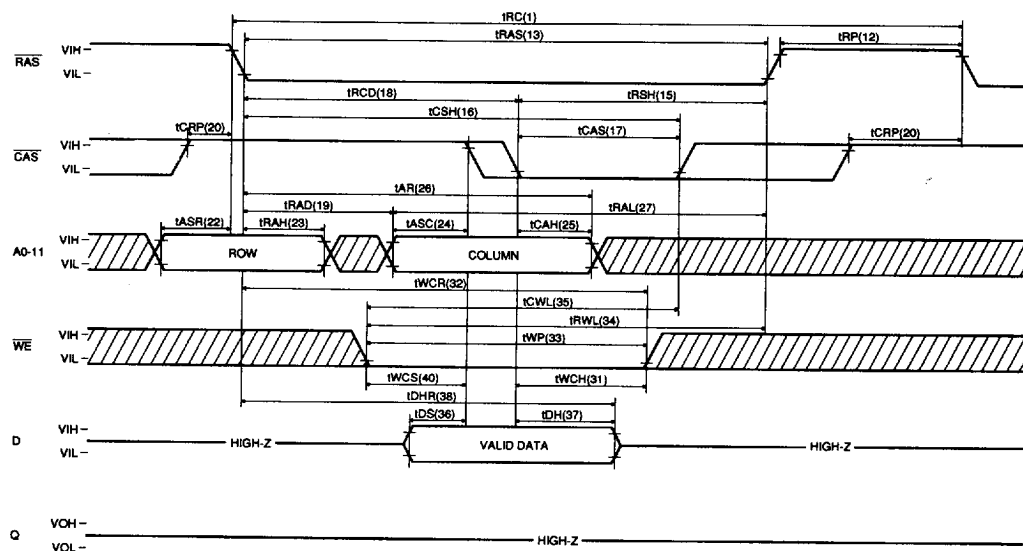
SYMBOL	PARAMETER	TYP.	MAX.	UNIT
C_{IN1}	Input Capacitance (A0-A11, D)	-	5	pF
C_{IN2}	Input Capacitance (RAS , CAS , WE)	-	7	pF
C_{OUT}	Data Output Capacitance (Q)	-	7	pF

TIMING DIAGRAM

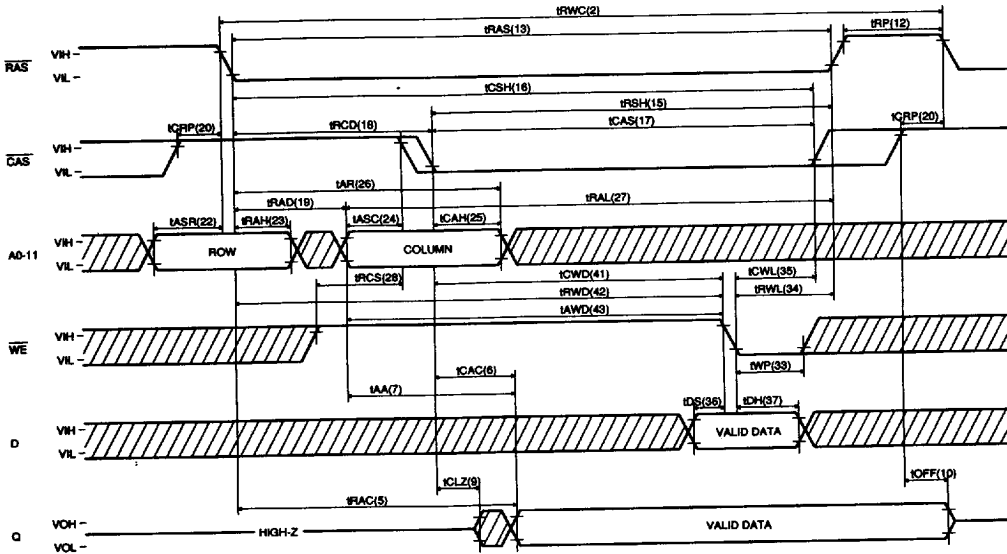
READ CYCLE



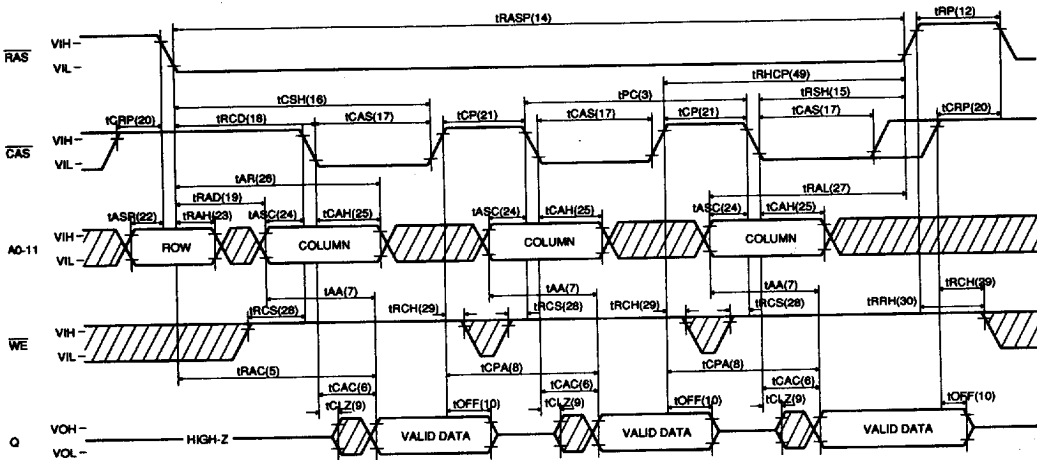
EARLY WRITE CYCLE



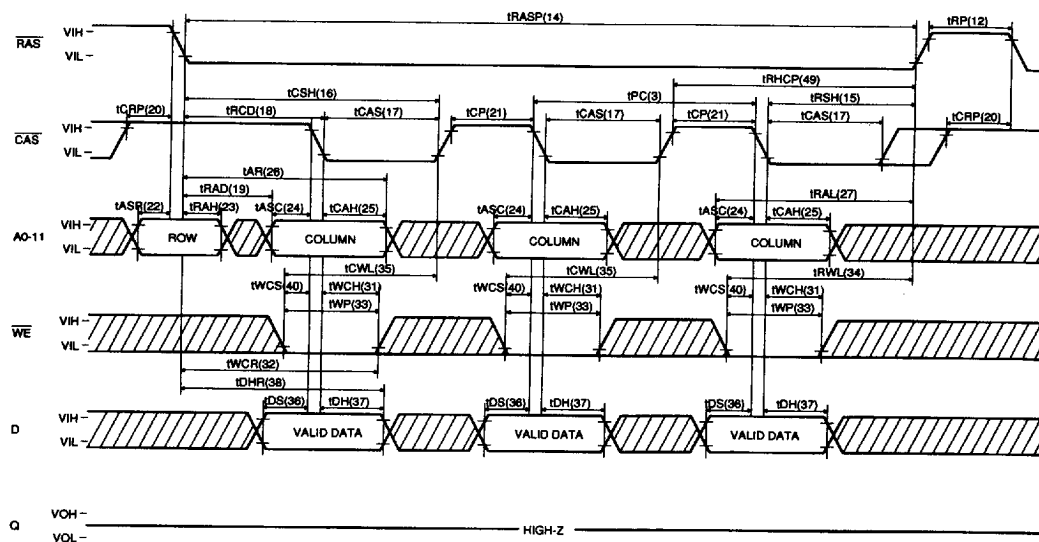
READ-MODIFY-WRITE CYCLE



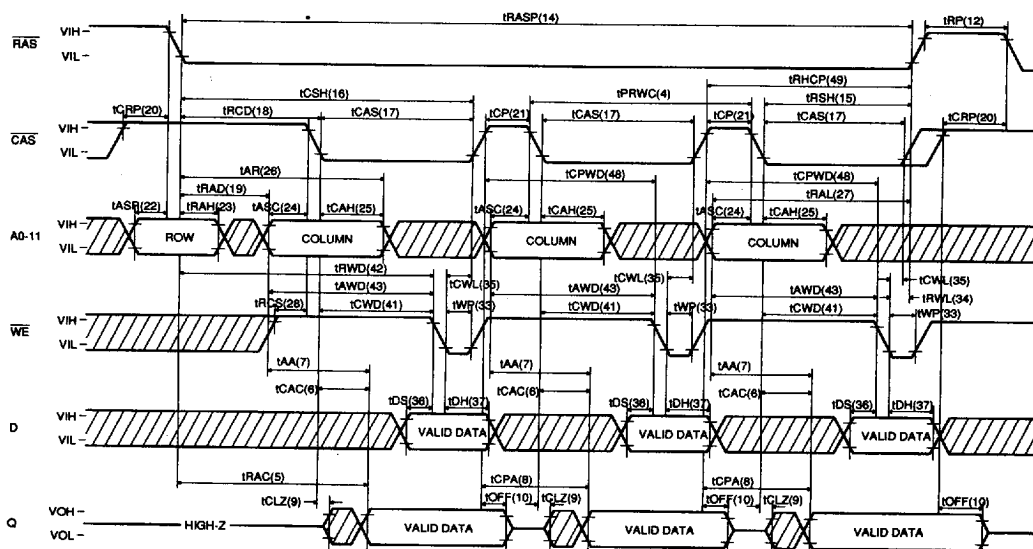
FAST PAGE MODE READ CYCLE



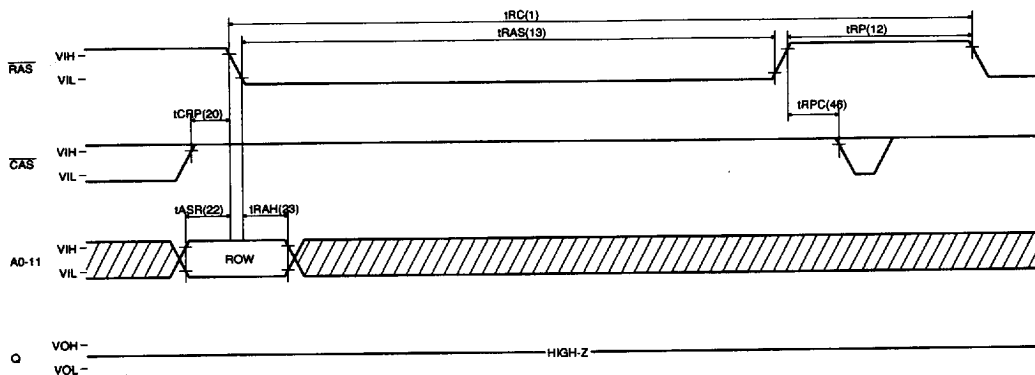
FAST PAGE MODE EARLY WRITE CYCLE



FAST PAGE MODE READ-MODIFY-WRITE CYCLE

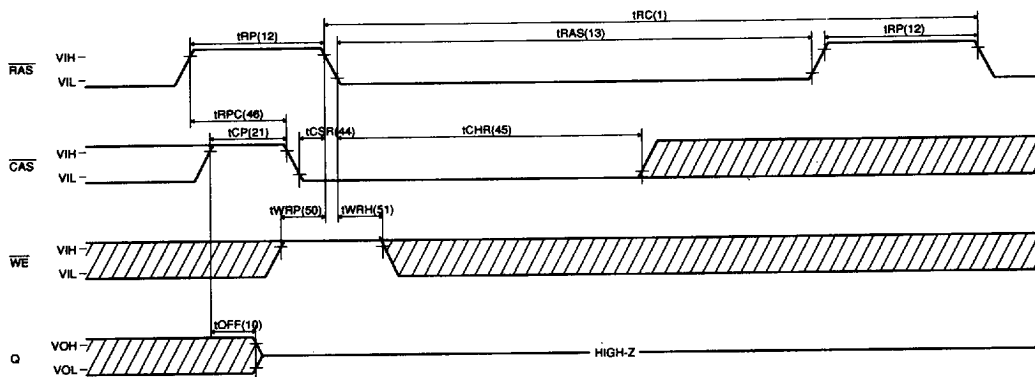


RAS-ONLY REFRESH CYCLE



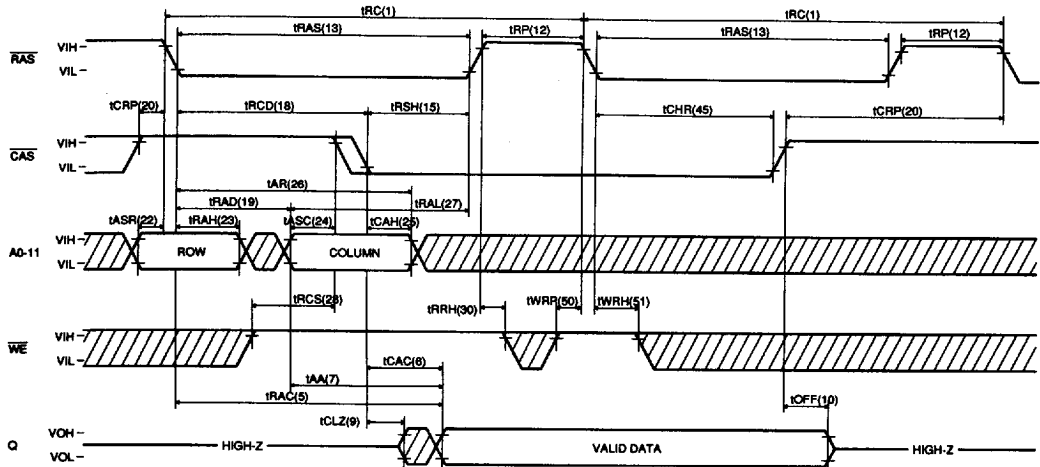
NOTE : WE = "H" or "L"

CAS-BEFORE-RAS REFRESH CYCLE

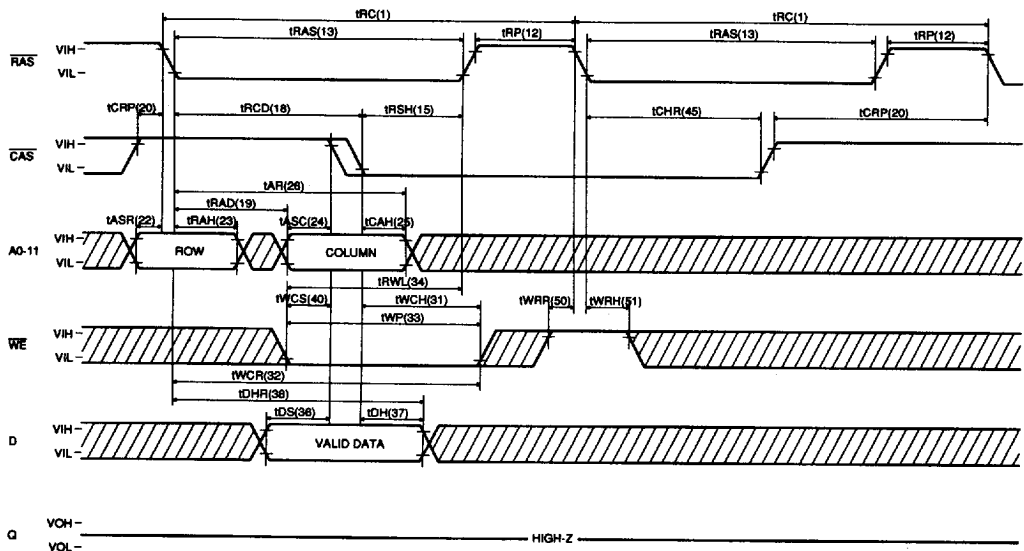


NOTE : A0 - A11 = "H" or "L"

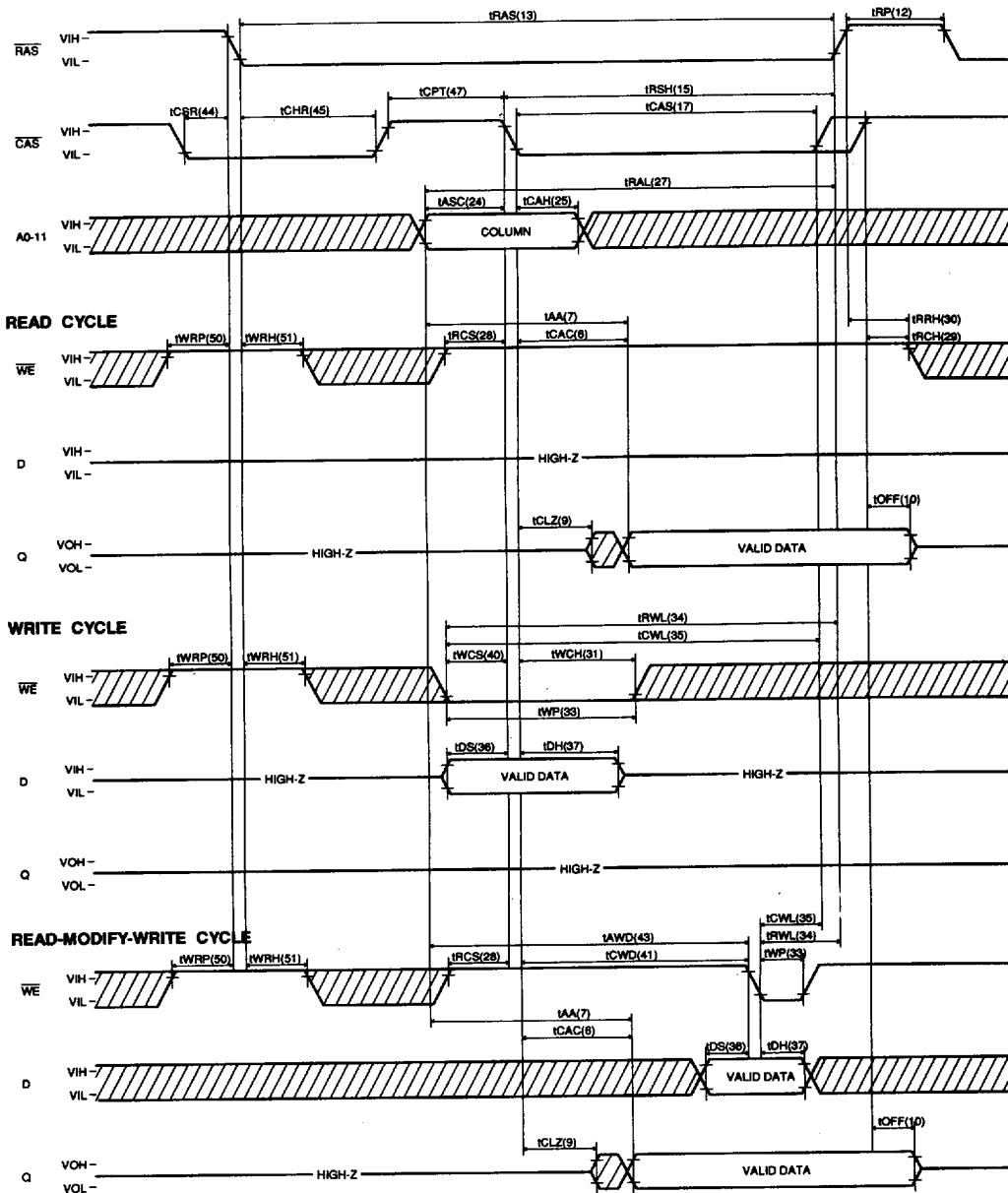
HIDDEN REFRESH CYCLE (READ)



HIDDEN REFRESH CYCLE (WRITE)



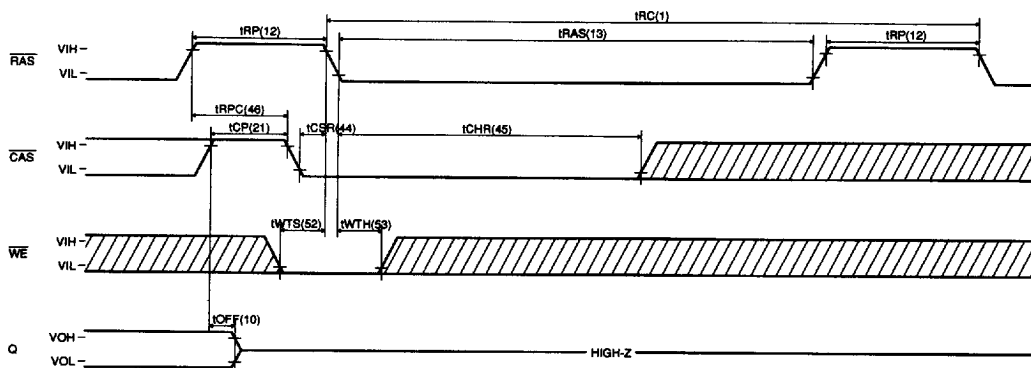
CAS-BEFORE-RAS REFRESH COUNTER TEST CYCLE



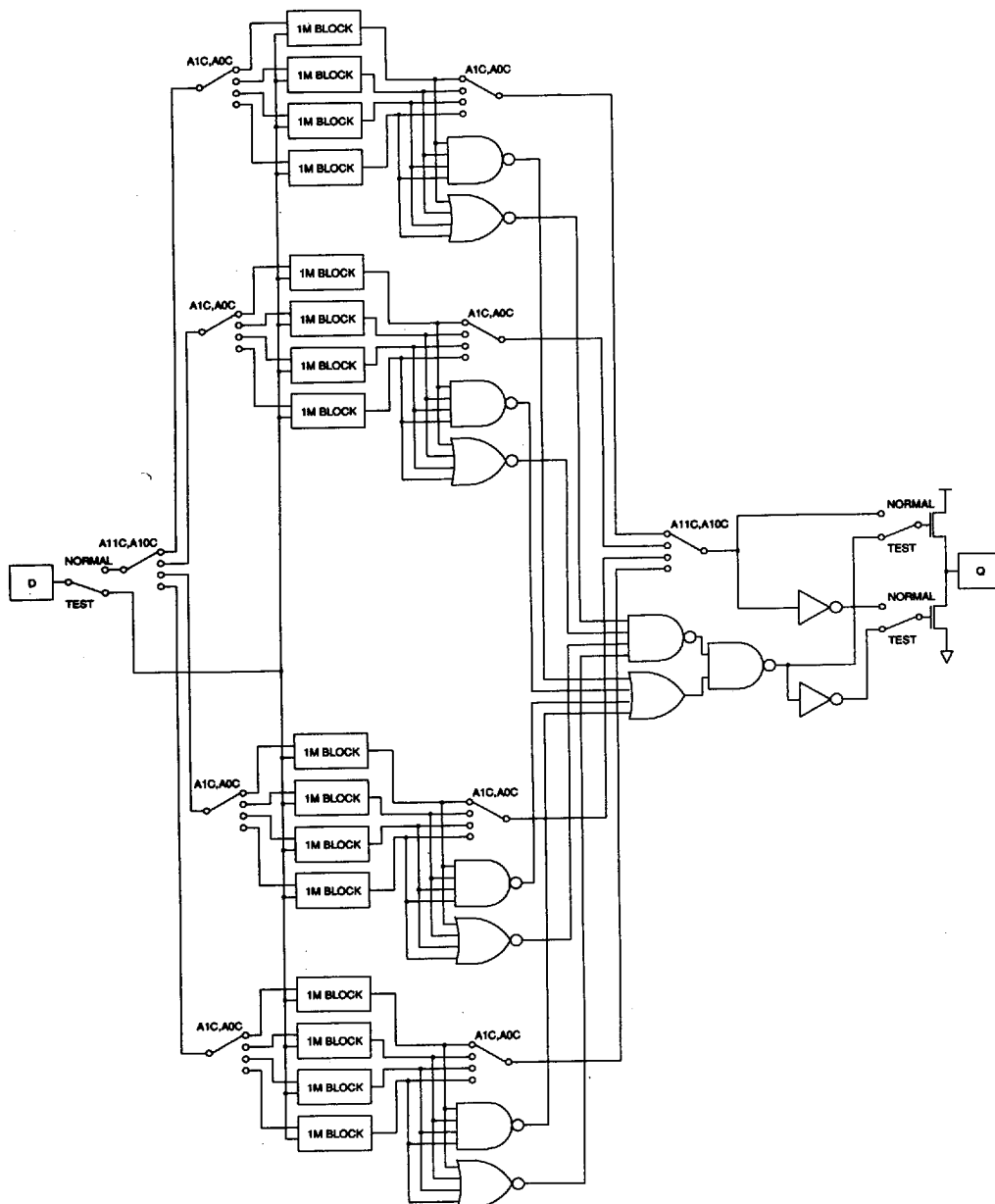
TEST MODE

The HY5117100 is a DRAM organized 16,777,216 x 1-bit. It is internally organized 1,048,576 x 16-bit. In Test Mode, data are written into 16 sectors (Each is composed of 1M bits) in parallel and retrieved the same way. Column address A0, A1, A10 and A11 are not used. If, upon reading, all bits are equal (all "1"s or "0"s), the Q pin indicates a "1". If they are not equal, the Q pin indicates a "0". Below shows the timing diagram of the HY5117100 to enter Test Mode. In Test Mode, the 16Mx1 DRAM can be tested as if it were a 1Mx1 DRAM. WE, CAS-before-RAS cycle (Test Mode In Cycle) puts the HY5117100 into Test Mode and CAS-before-RAS or RAS-only refresh cycle puts it back into Normal Mode. In Test Mode, WE, CAS-before-RAS cycle shall be used for the refresh operation. The Test Mode function reduces test time (1/16 in case of N test pattern).

TEST MODE IN CYCLE

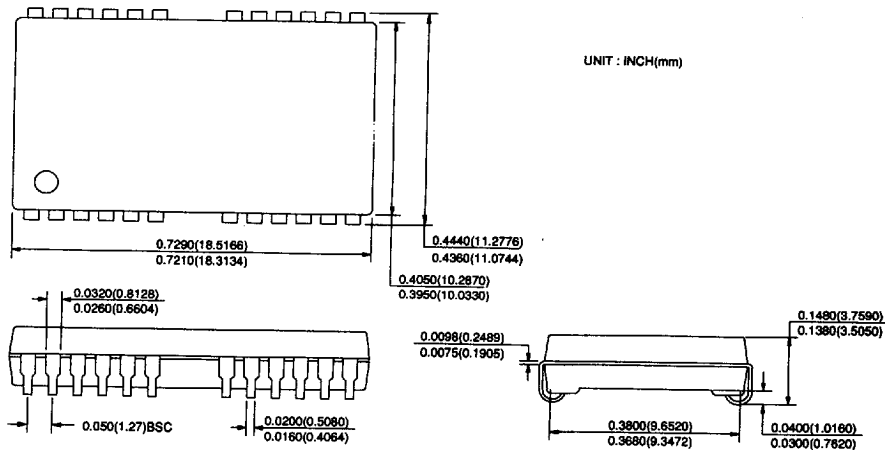


BLOCK DIAGRAM IN TEST MODE

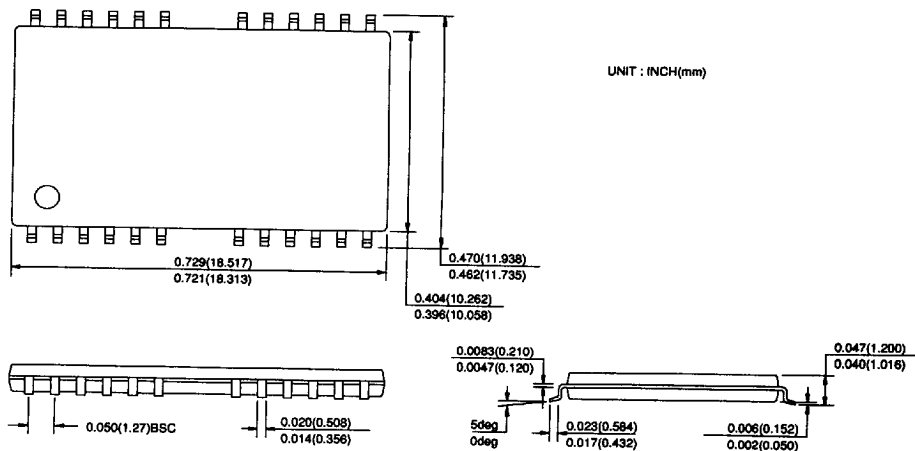


PACKAGE INFORMATION

400 mil 24/28 pin Small Outline J-form Package (JC)



400 mil 24/28 pin Thin Small Outline Package (TC) (RC)



ORDERING INFORMATION

PART NO	SPEED	POWER	PACKAGE
HY5117100JC	60/70/80		SOJ
HY5117100LJC	60/70/80	L-part	SOJ
HY5117100TC	60/70/80		TSOP-II
HY5117100LTC	60/70/80	L-part	TSOP-II
HY5117100RC	60/70/80		TSOP-II(R)
HY5117100LRC	60/70/80	L-part	TSOP-II(R)